申請書記入要領 《For International Students》 Guideline for Application for Tuition Fee Exemption

tion Fee Exemption - Academic Year 2025 (Second Half)

To: The President, The University of Tokyo

I hereby apply for a tuition exemption for the second half of the 2025 academic year.

All the information in this application form and the attached documents are true and correct. If there are any discrepancies between the information in the application form and the attached documents, I have no objection to the revocation of the exemption.

Colleg	e/Facu	ılty/Gradua	te school Graduate School of Engineering				Ig Name in KA	TAKANA	トワダイーダロワ					
St	uden	t Positio	Master's program 37256XXX				Applicant	Name	TODAI Taro					
S	tuder	nt ID No.												
			o. of <u>previous year</u> 03XXXXXX			(XXXXX	Date	е		2025.10.1				
(If it is different			from the current number)				Signat	ure		TODAI Taro				
Pleas	se cir	cle the a	pprop	oriate item where ma	arked w	ith "*".	*Signatu	re mu	st be handwritten	. Typed	l signatures are	not accepted.		
• • •		on type	* (	Admission fee	<b>→</b> €			onc	l Half) • Tu	uitio	n fee(Rea	apply)		
Admission  (Advancement)			(yyyy/mm) 2025 /			Second bache  * Transferees	elor's degree ②		② International Students circle box on right→					
Mobile Phone:			080-XXXX-XXXX E-mail Address				XXXXXXX@g.ecc.u-tokyo.ac.jp							
③Address				③Address (本人住所) ④	Family hor	amily home address (家族(父母)			Postal code:					
			well as your family home add			dress in Japan and your contact infor dress in your country.			Laboratory Phone No	:				
④Family address				☆If your address changes notify Scholarship team a	after subr s soon as p	mitting the application, possible.	please		Phone Number					
	Relationship			Name	Age	* Marital Status	Name of Institution	Year	*Living Arrange	ment	Income type 1	Income type 2		
	Applicant		TODA	Al Taro	24	Single Married	University of Tokyo	М1	Home · Diff	erent				
	Relationship		Name			Occupation		Р	lace of work					
	Father		00	00	55 (\$)Family Information(家族状況) Please enter details of your parents as well as any family members (spou			and yourself						
	Mother		×× ×× 50			living in Japan.								
	Father/motherless family		^	ther Death • Sepother Date [	oarated •	arated • Other [ (yyyy/mm)] Child-suppor			urvivors' Pension * Yes • No					
tion	Relationship		Name		Age	* Name of Institution		Year	*Living Arrange	ment				
Informa	ndents				National • Public		• Private			erent				
®Family Information	Enrolled as students					National • Public •	• Private		Home • Different					
						National • Public •	• Private		Home • Diff	erent				
	Relationship			Name	Age	Age Occupation		Place of work Period of Employment						
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	illed a													
	Not enrolled students													
	No													
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Do not write anything in this section 1

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lars	Da		AY2024 (from April 2024 t	o March 2025)	AY2025 (from April 2025 to March 2026)			
	Do you red	ceive any scholarships?	* Yes • No If Yes, fill o	out the section below	*Yes • No If Yes, fill out the section below			
	Organization N	Iame (Name of Scholarship)	Duration (yyyy/mm~yyyy/mm)	Amount	Duration (yyyy/mm~yyyy/mm)	Amount		
		Grant	⑥Scholarship Information (奨学	.м		¥		
Schola	JASSO	Type 1	If you are receiving (or received) a current academic year, please enti	scholarship in the previ	ious or	¥		
	3A330	Type 2	current academic year, please end			¥		
		MEXT Honors		¥		¥		
6	XXXX Sch	olarship Foundation		¥	2025.4~2026.3	¥ 50000 per month		
				¥		¥		

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Personal Background (University, Job, etc.)		00/00	gr	raduated from OO High school	00	OOO/OO joined XXXX Co.					
Back, ity, Jo		0000	0/00	entered OO University	○○○/○○ resigned from XXXX Co.						
rsona  nivers		0000/0	) gra	aduated from OO University	demic Backgroun	nd/Work Experience					
Pe (U		Please provide academic background from high school graduation to current and work experience.									
7											
Tuition Exemption Status	AY 2024	First half	*Applied	for the whole year • Did not apply	• Leave of absence	ce					
Tuition ıption St	AY 2	Second half	econd half *Applied for the whole year/Second half only reapply • Did not apply • Leave of absence								
- Exem	AY 2025	First half	*Applied	pplied for the whole year • Did not apply • Leave of absen <b>9Student Status</b> • Please enter the exact per							
8		Second half	*Applied	for Second half only / reapply · Did	not apply · Lea	reason for the leave of absonce if					
Student Status	*S	tudy Abroad	• Leave	e of Absence Reason (	Students who studied abroad please	m)					
Stuc	*\$	tudy Abroad	• Leave	e of Absence Reason (	)	enter the period , country and exact name of the institution in the "reason"	m)				
9	*S	tudy Abroad	• Leave	e of Absence Reason (	(m) ه پېرېرېرو د ۱۳۰۰ مېړو و و و و پ						
		extending		on ( * Illness • Leave of absence • St	tudying abroad •	®Reason for extending beyond the standard course period	) fill				
period	a tne si	andard cour		me and Position of academic advisor		and the state of t	m 8				
	(Re	equired)				advisor if you are enrolled beyond the standard program duration.					
ing f	I came	to Japan al	one to p	oursue my studies, while my family rema		are					
Reason for Applying for Exemption	prima	rily supporte	d by my	y family, but due to ▲▲ (e.g., economic	☆Please make sure to submit Form8 "Reason for extending beyond the						
or A <sub>l</sub> emp	suppo	rting me has	decline	ed.	standard course period "along with						
on f	primarily supported by my family, but due to $\triangle \triangle$ (e.g., economic difficulties, unexp "Please make sure to submit Form8 "Reason for extending beyond the standard course period "along with this application form."  In addition, I have $\triangle$ siblings (or children) who are currently enrolled in school, and family is increasing. While I am trying to cover part of my living costs through part-time week, the application form.  Challenging, and my financial situation remains difficult.										
Reas	family is increasing. While I am trying to cover part of my living costs through part-time work; waarking to warring studies 15.										
	challe	challenging, and my financial situation remains difficult.									
For these reasons, I would like to apply for a tuition exemption. Thank you for your consideration.							ation				
	If the m	nember suppo	rting	Date when unemployed (	write this section in English, please attach a Japanese translation.						
_		usehold is	Ü		household i	②In case that the family member supporting the household is out of employment					
	unemp	loyed		Current source of living expenses (		l in if applicable. Only for yourself and any embers living in Japan.					
ies	Relation	Name		*Deduction f	<u>vers riving in Japan.</u>						
oillit	Mental & physical disabilit						15				
Disabilities	Long term treatment • Lor Please fill in if there are family m					members with disabilities, with the need					
				Mental & physical disability of chronic care, or with the need of care. Only for yourself and any family members living in Japan.							
(12)			1 1	ong term treatment . Les Unly for your	sen and any famil	y members living in Japan.					

## Important Notes for Admission/Tuition Exemption Application (Please read carefully before filling out the form)

## 1. Completing the Form

- Make sure all required fields are filled in. Incomplete applications may not be accepted.
- Information must reflect your actual status as of October 1 for the second semester.
- If false information is intentionally provided, the exemption may be cancelled even after approval.

## 2. Signature Requirements

- You must sign the application form yourself.
- The signature field must be handwritten.
- Use a black pen or ballpoint pen.
- Pencils or erasable pens are not allowed.
- All other sections can be filled in by computer.

## 3. Validity of Application

- This exemption application is valid only for the current academic year: April 1, 2025 March 31, 2026.
- If you continue your studies in the next academic year, you must submit a new application for April 1, 2026 March 31, 2027.